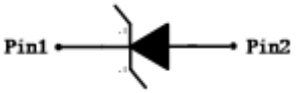
1-Line, Uni-directional, Transient Voltage Suppressor





DFN1006-2L

Features

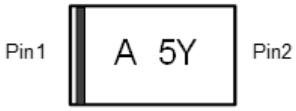
- Ultra small package
- Stand-off voltage: 5V Max
- Transient protection for each line according to
  IEC61000-4-2(ESD): ±30kV (contact)
  IEC61000-4-5(surge): 12A (8/20μs)
- Ultra-low capacitance: CJ = 0.33 pF typ
- Low leakage current
- Low clamping voltage
- RoHS Compliant

Applications

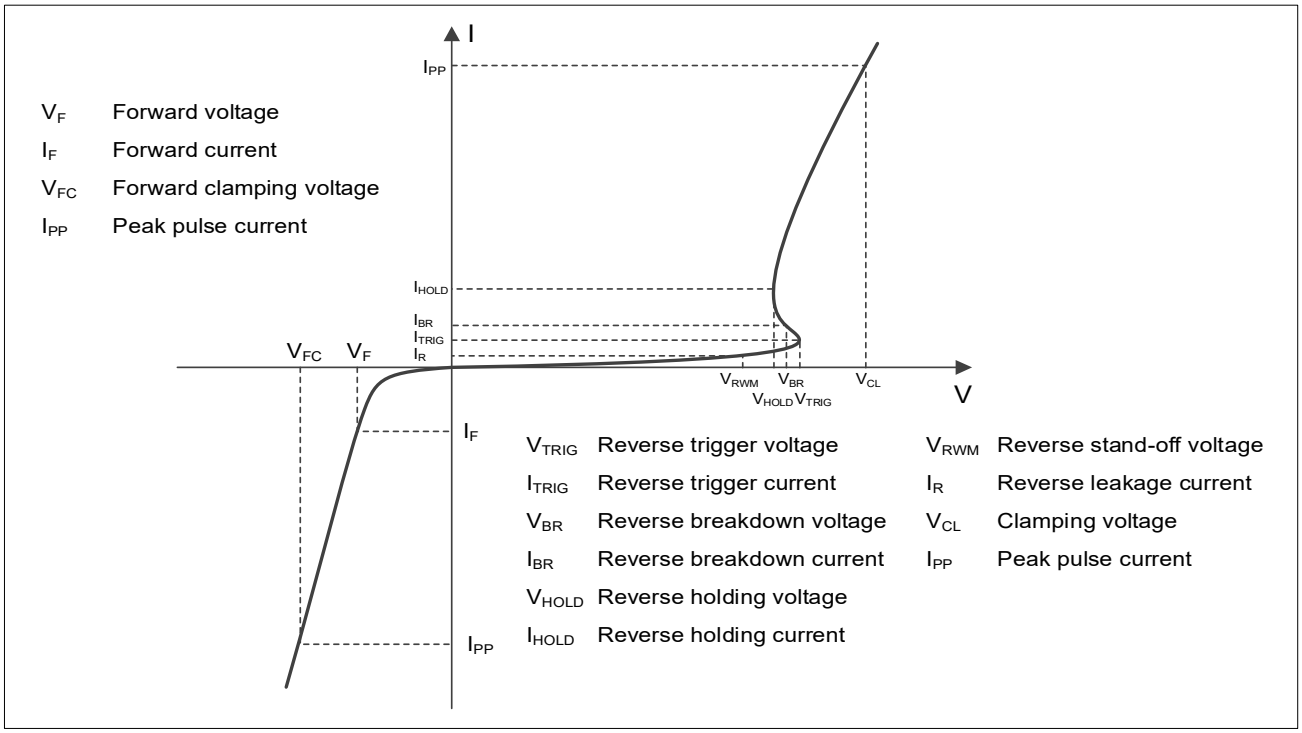
- USB 2.0 and USB 3.0
- HDMI 1.3, HDMI 1.4 and HDMI 2.0
- SATA and eSATA interface
- DVI
- IEEE 1394
- Portable Electronics and Notebooks
- Ethernet port: 10/100/1000 Mb/s
- Desktop and Notebooks PCs

Mechanical Characteristics

- Package: DFN1006-2L
- Case Material: “Green” Molding Compound.
- Marking Information: See Below



■Definitions of electrical characteristics



■Absolute Maximum Ratings (Ta=25°C unless otherwise specified)

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power (t_p = 8/20μs)	P_{pk}	132	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	12	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	KV
ESD according to IEC61000-4-2 contact discharge		±30	KV
Junction temperature	T_J	125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics (Ta=25℃ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				5
Reverse breakdown voltage	V_{BR}	V	I_{BR} = 1mA	5.5		
Reverse leakage current	I_R	nA	V_{RWM} =5V			100
Clamping voltage [3]	V_{CL}	V	I_{PP} = 1A, t_p = 8/20μs			6
		V	I_{PP} = 12A, t_p = 8/20μs			11
Junction capacitance	C_J	pF	V_R = 0V, f = 1MHz		0.33	0.65

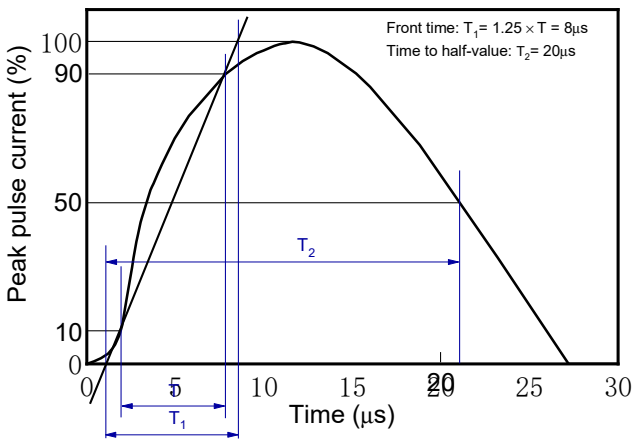
(1). TLP parameter: Z_0 = 50Ω, t_p = 100ns, t_r = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.
(2). Contact discharge mode, according to IEC61000-4-2.
(3). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

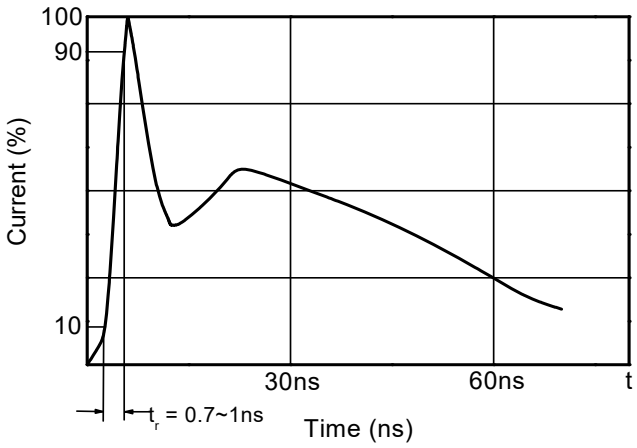
PREFERED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESDSLC5V0L1	Approximate 0.9	10000	40000	120000	Tae& reel

■ Typical Performance Characteristics (Ta=25℃ unless otherwise Specified)

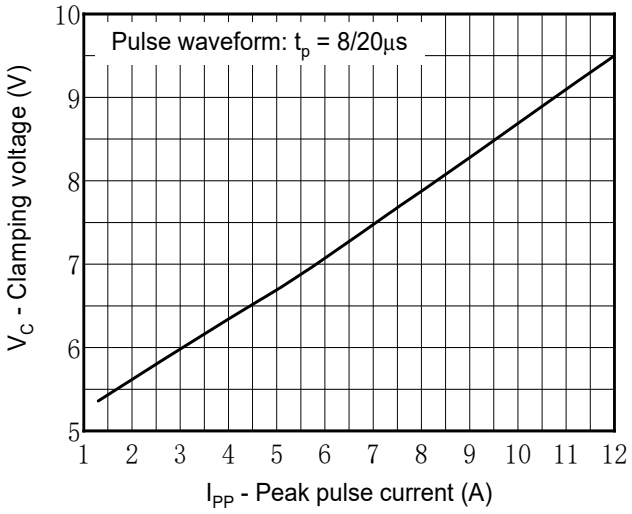
8/20μs waveform per IEC61000-4-5



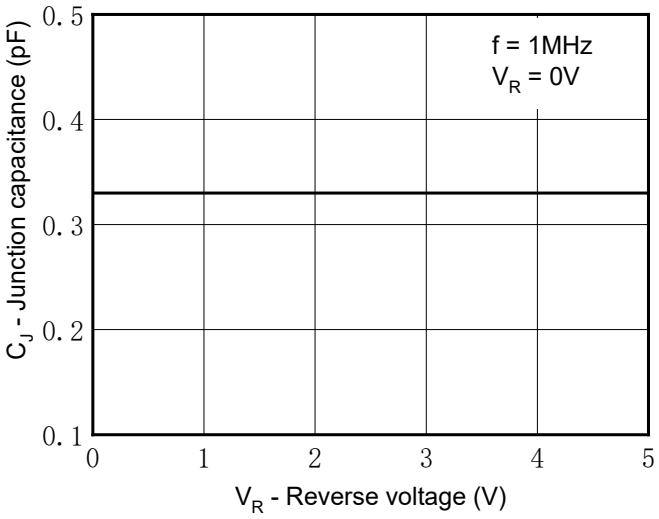
Contact discharge current waveform per IEC61000-4-2



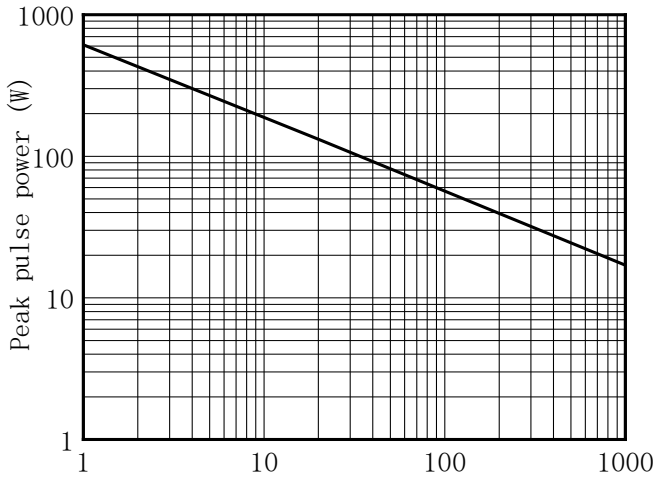
Clamping voltage vs. Peak pulse current



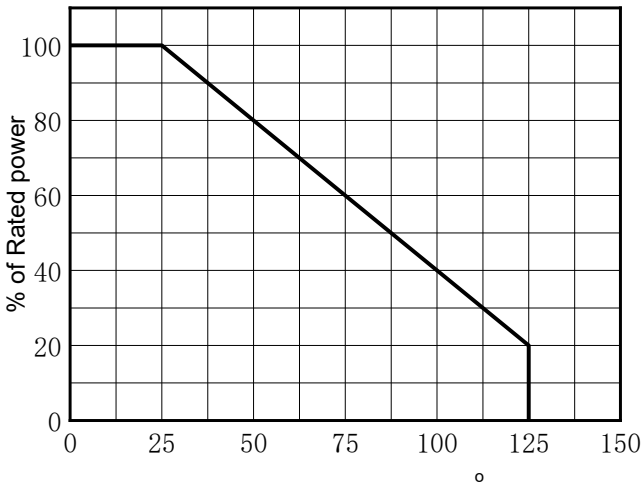
Capacitance vs. Reverse voltage

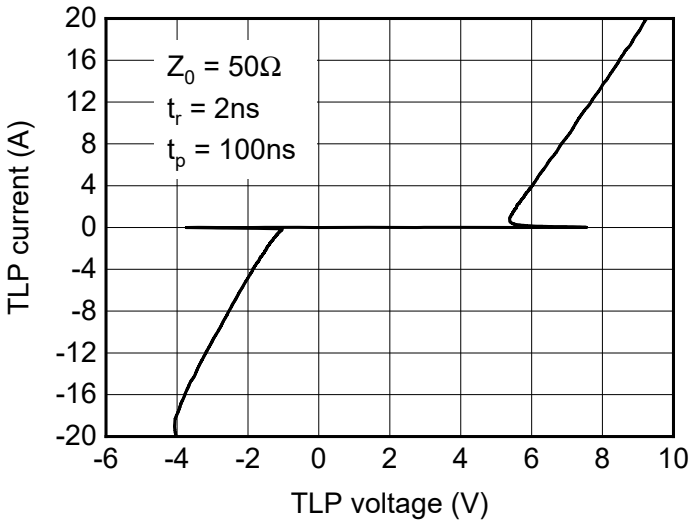


Non-repetitive peak pulse power vs. Pulse time

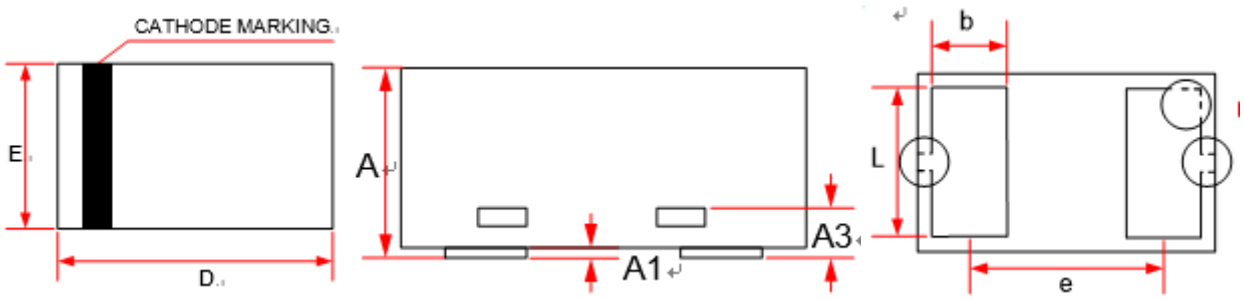


Power derating vs. Ambient temperature



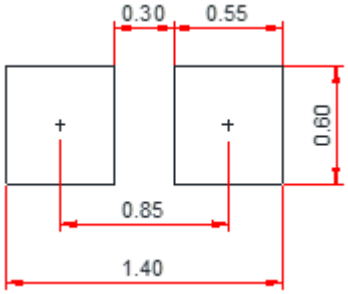

20
16
12
8
4
0
-4
-8
-12
-16
-20
-6
-4
-2
0
2
4
6
8
10
Z_0 = 50Ω
t_r = 2ns
t_p = 100ns
TLP current (A)
TLP voltage (V)

■ Outline Dimensions



Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.340	-	0.550
A1	0.000	0.020	0.050
A3	0.125 Ref.		
D	0.950	1.000	1.075
E	0.550	0.600	0.675
b	0.200	0.250	0.300
L	0.450	0.500	0.550
e	0.650 BSC		

■ Recommend land pattern (Unit:mm)



Notes:
This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met

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